TOSHIBA CMOS Digital Integrated Circuit Silicon Monolithic

# TC74LCX32F,TC74LCX32FN,TC74LCX32FT,TC74LCX32FK

Low-Voltage Quad 2-Input OR Gate with 5-V Tolerant Inputs and Outputs

The TC74LCX32 is a high-performance CMOS 2-input OR gate. Designed for use in 3.3-V systems, it achieves high-speed operation while maintaining the CMOS low-power dissipation.

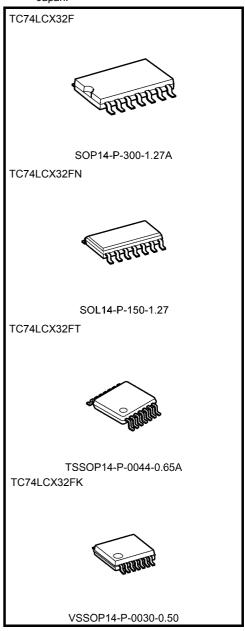
The device is designed for low-voltage (3.3 V) VCC applications, but it could be used to interface to 5-V supply environment for inputs

All inputs are equipped with protection circuits against static discharge.

#### **Features**

- Low-voltage operation: VCC = 1.65 to 3.6 V
- High-speed operation:  $t_{pd} = 5.5 \text{ ns (max) (V}_{CC} = 3.0 \text{ to } 3.6 \text{ V)}$
- Output current:  $|I_{OH}|/I_{OL} = 24 \text{ mA (min) (V}_{CC} = 3.0 \text{ V)}$
- Latch-up performance:  $> \pm 500 \text{ mA}$
- Available in JEDEC SOP, JEITA SOP, TSSOP and VSSOP (US)
- Power-down protection is provided on all inputs and outputs
- Pin and function compatible with the 74 series (74AC/VHC/HC/F/ALS/LS etc.) 32 type

Note: xxxFN (JEDEC SOP) is not available in Japan.



Weight

 SOP14-P-300-1.27A
 : 0.18 g (typ.)

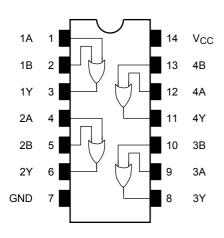
 SOL14-P-150-1.27
 : 0.12 g (typ.)

 TSSOP14-P-0044-0.65A
 : 0.06 g (typ.)

 VSSOP14-P-0030-0.50
 : 0.02 g (typ.)

Note: The Electrical Characteristics of  $V_{CC}$ =1.8±0.15V is only applicable for products which manufactured from January 2009 onward.

#### Pin Assignment (top view)



### **IEC Logic Symbol**

1A — 1 1B — 2	≥ 1	3 1Y
2A		6 20
2B5		<del>6</del> 2Y
3A — 9		8 21/
3B <u>10</u>		8 3Y
4A <u>12</u>		11 41/
4B <u>13</u>		<u>11</u> 4Y

#### **Truth Table**

Inp	uts	Outputs
Α	В	Y
L	L	L
L	Н	Н
Н	L	Н
Н	Н	Н

### **Absolute Maximum Ratings (Note 1)**

Characteristics	Symbol	Rating	Unit
Power supply voltage	V <sub>CC</sub>	-0.5 to 7.0	V
DC input voltage	V <sub>IN</sub>	-0.5 to 7.0	V
		-0.5 to 7.0 (Note 2)	
DC output voltage	V <sub>OUT</sub>	-0.5 to V <sub>CC</sub> + 0.5 (Note 3)	V
Input diode current	I <sub>IK</sub>	-50	mA
Output diode current	lok	±50 (Note 4)	mA
DC output current	lout	±50	mA
Power dissipation	PD	180	mW
DC V <sub>CC</sub> /ground current	I <sub>CC</sub> /I <sub>GND</sub>	±100	mA
Storage temperature	T <sub>stg</sub>	-65 to 150	°C

Note 1: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction.

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 2:  $V_{CC} = 0 V$ 

Note 3: High or low state. IOUT absolute maximum rating must be observed.

Note 4:  $V_{OUT} < GND$ ,  $V_{OUT} > V_{CC}$ 



## **Operating Ranges (Note 1)**

Characteristics	Symbol	Rating	Unit	
Power supply voltage	V <sub>CC</sub>	1.65 to 3.6	V	
Power supply voltage	v CC	1.5 to 3.6 (Note 2)	V	
Input voltage	V <sub>IN</sub>	0 to 5.5	V	
Output voltage	V <sub>OUT</sub>	0 to 5.5 (Note 3)	V	
Output voltage		0 to V <sub>CC</sub> (Note 4)	V	
Output current	I <sub>OH</sub> /I <sub>OL</sub>	±24 (Note 5)	mA	
Output current	iOH/iOL	±12 (Note 6)	ША	
Operating temperature	T <sub>opr</sub>	-40 to 85	°C	
Input rise and fall time	dt/dv	0 to 10 (Note 7)	ns/V	

Note 1: The operating ranges must be maintained to ensure the normal operation of the device. Unused inputs must be tied to either  $V_{CC}$  or GND.

Note 2: Data retention only

Note 3:  $V_{CC} = 0 V$ 

Note 4: High or low state

Note 5:  $V_{CC} = 3.0 \text{ to } 3.6 \text{ V}$ 

Note 6:  $V_{CC} = 2.7 \text{ to } 3.0 \text{ V}$ 

Note 7:  $V_{IN} = 0.8$  to 2.0 V,  $V_{CC} = 3.0$  V

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## **Electrical Characteristics**

### DC Characteristics ( $Ta = -40 \text{ to } 85^{\circ}\text{C}$ )

Characteristics		Symbol Test Condition			Min	Max	Unit	
Silarastoristi	-	Cymbol	V <sub>CC</sub> (V)		V <sub>CC</sub> (V)		Max	Orm
			1.		1.65 to 2.3	V <sub>CC</sub> × 0.9		
	H-level	V <sub>IH</sub>	_		2.3 to 2.7	1.7	_	
Input voltage					2.7 to 3.6	2.0	_	V
input voltage					1.65 to 2.3	_	V <sub>CC</sub> × 0.1	V
	L-level	VIL	_		2.3 to 2.7	_	0.7	
					2.7 to 3.6	_	0.8	
				$I_{OH} = -100 \mu A$	1.65 to 3.6	V <sub>CC</sub> -0.2	_	
				$I_{OH} = -4 \text{ mA}$	1.65	1.05	_	
	H-level	\/-··	V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub>	$I_{OH} = -8 \text{ mA}$	2.3	1.7	_	V
	n-ievei	VoH	VIN = VIH OF VIL	$I_{OH} = -12 \text{ mA}$	2.7	2.2	_	
				I <sub>OH</sub> = -18 mA	3.0	2.4	_	
Output voltage				I <sub>OH</sub> = -24 mA	3.0	2.2	_	
Output voltage			I <sub>OL</sub> = 100	I <sub>OL</sub> = 100 μA	1.65 to 3.6	_	0.2	
				I <sub>OL</sub> = 4 mA	1.65	_	0.45	
	L-level V <sub>OL</sub> V <sub>IN</sub> = V <sub>IL</sub>	.,	., .,	I <sub>OL</sub> = 8 mA	2.3	_	0.7	
		VOL	VIN = VIL	I <sub>OL</sub> = 12 mA	2.7	_	0.4	
		I <sub>OL</sub> = 16 mA	3.0	_	0.4			
				I <sub>OL</sub> = 24 mA	3.0	_	0.55	
Input leakage current		I <sub>IN</sub>	V <sub>IN</sub> = 0 to 5.5 V		1.65 to 3.6	_	±5.0	μА
Power-off leakage curr	ent	I <sub>OFF</sub> V <sub>IN</sub> /V <sub>OUT</sub> = 5.5 V 0		$V_{IN}/V_{OUT} = 5.5 V$		_	10.0	μА
Quiggaant gupply gurrent		Icc	V <sub>IN</sub> = V <sub>CC</sub> or GND		1.65 to 3.6	_	10.0	
Quiescent suppry curre	Quiescent supply current		V <sub>IN</sub> = 3.6 to 5.5 V		1.65 to 3.6	_	±10.0	μΑ
Increase in Icc per inpu	ıt	Δlcc	$V_{IH} = V_{CC} - 0.6 V$	V <sub>IH</sub> = V <sub>CC</sub> - 0.6 V		500		



#### AC Characteristics (Ta = -40 to 85°C)

Characteristics	Symbol	Test Condition V <sub>CC</sub> (V)		Min	Max	Unit
Propagation delay time		Figure 1, Figure 2	$1.8 \pm 0.15$	_	20.0	-
	t <sub>pLH</sub> t <sub>pHL</sub>		2.5 ± 0.2	_	7.2	
			2.7	_	6.2	ns
			$3.3\pm0.3$	1.5	5.5	
Output to output skew	t <sub>osLH</sub>	(Note)	2.7			ns
	t <sub>osHL</sub>		$3.3 \pm 0.3$		1.0	115

Note: Parameter guaranteed by design.

 $(t_{OSLH} = |t_{PLHm} - t_{PLHn}|, t_{OSHL} = |t_{PHLm} - t_{PHLn}|)$ 

### Dynamic Switching Characteristics (Ta = 25°C, input: $t_r = t_f = 2.5$ ns, $C_L = 50$ pF, $R_L = 500$ $\Omega$ )

Characteristics	Symbol	Test Condition	V <sub>CC</sub> (V)	Тур.	Unit
Quiet output maximum dynamic V <sub>OL</sub>	V <sub>OLP</sub>	V <sub>IH</sub> = 3.3 V, V <sub>IL</sub> = 0 V	3.3	8.0	V
Quiet output minimum dynamic V <sub>OL</sub>	V <sub>OLV</sub>	$V_{IH} = 3.3 \text{ V}, V_{IL} = 0 \text{ V}$	3.3	8.0	V

#### **Capacitive Characteristics (Ta = 25°C)**

Characteristics	Symbol	Test Condition	V <sub>CC</sub> (V)	Тур.	Unit
Input capacitance	C <sub>IN</sub>	_	3.3	7	pF
Output capacitance	C <sub>OUT</sub>	_	0	8	pF
Power dissipation capacitance	C <sub>PD</sub>	$f_{IN} = 10 \text{ MHz}$ (No.	e) 3.3	25	pF

Note: C<sub>PD</sub> is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load.

Average operating current can be obtained by the equation:

 $I_{CC \text{ (opr)}} = C_{PD} \cdot V_{CC} \cdot f_{IN} + I_{CC}/4 \text{ (per gate)}$ 



### **AC Test Circuit**

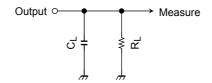


Figure 1

### **AC Waveform**

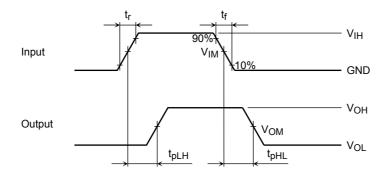


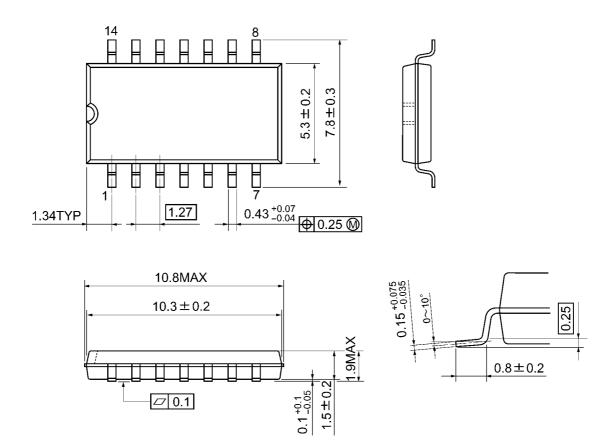
Figure 2 t<sub>pLH</sub>, t<sub>pHL</sub>

		Vcc					
	Symbol	3.3 ± 0.3 V 2.7V	2.5 ± 0.2 V	1.8 ± 0.15 V			
Input	V <sub>IH</sub>	2.7V	V <sub>CC</sub>	V <sub>CC</sub>			
	V <sub>IM</sub>	1.5V	V <sub>CC</sub> /2	V <sub>CC</sub> /2			
	tr,tf	2.5ns	2.0ns	2.0ns			
Output	V <sub>OM</sub>	1.5V	V <sub>OH</sub> /2	V <sub>OH</sub> /2			
Load	C <sub>L</sub>	50pF	30pF	30pF			
	RL	500Ω	500Ω	1kΩ			



# **Package Dimensions**

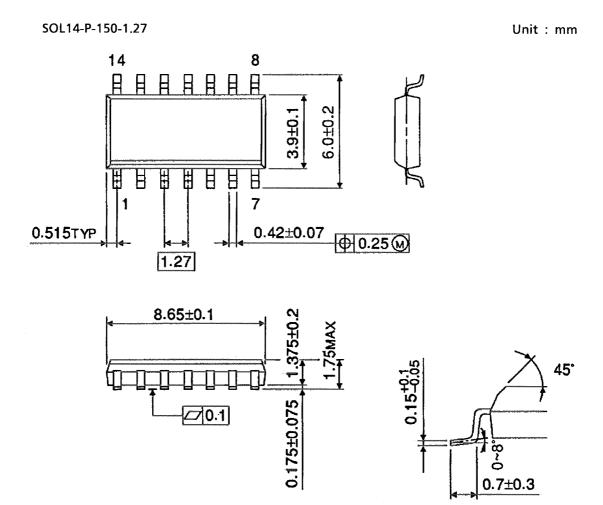
SOP14-P-300-1.27A Unit: mm



Weight: 0.18 g (typ.)



# **Package Dimensions (Note)**



Note: This package is not available in japan.

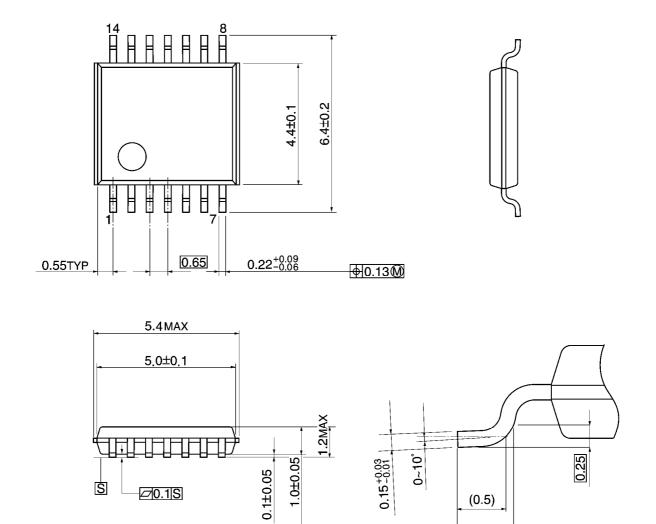
Weight: 0.12 g (typ.)



# **Package Dimensions**

TSSOP14-P-0044-0.65A

Unit: mm



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Weight: 0.06 g (typ.)

S

Ø.1S

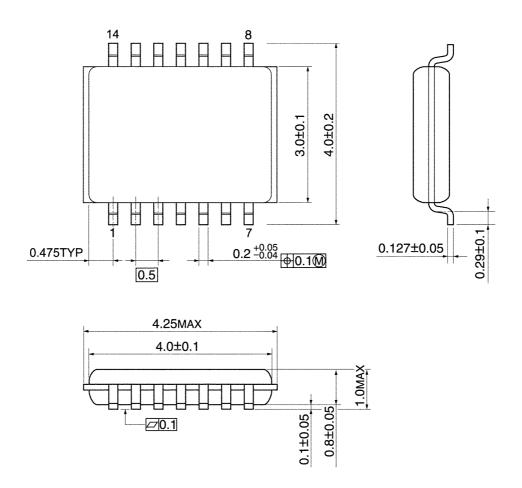
(0.5)

0.45~0.75



## **Package Dimensions**

VSSOP14-P-0030-0.50 Unit: mm



Weight: 0.02 g (typ.)

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